
Addendum to
MC68HC05P6
HCMOS Microcontroller Unit
Technical Data

This addendum provides corrections and additions to the *MC68HC05P6 Technical Data*, Rev. 0 (Motorola document number MC68HC05P6/D).

1. Page 1-1, section **1.1 Features** — Change the third bulleted item as follows:

From:

- 4672 Bytes of User ROM Including 48 Bytes of Page Zero ROM and 16 User Vector Locations

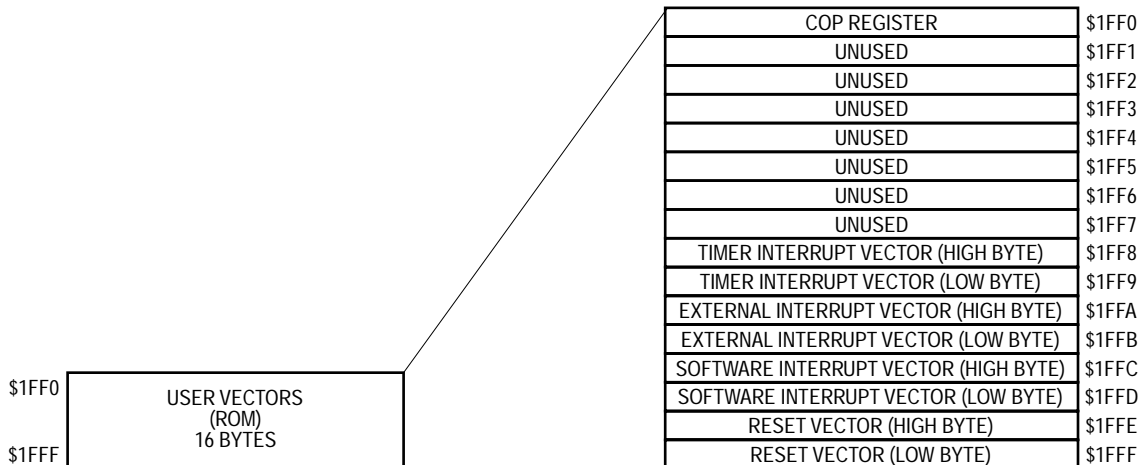
To:

- 4664 Bytes of User ROM Including 48 Bytes of Page Zero ROM and 8 User Vector Locations



2. Page 2-2, **Figure 2-1. Memory Map** — Change the USER VECTORS portion at the bottom of the map as follows:

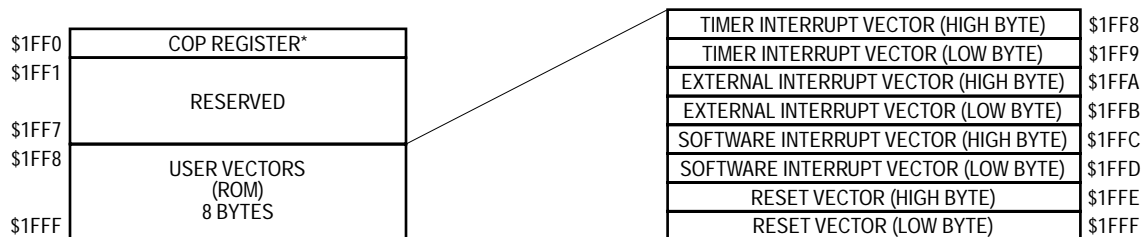
From:



*Writing zero to bit 0 of \$1FF0 clears the COP watchdog timer. Reading \$1FF0 returns user ROM data.

Figure 2-1. Memory Map

To:



3. Page 2-4, section **2.4 ROM** — Change the third bulleted item as follows:

From:

- Addresses \$1FF0–\$1FFF contain 16 bytes of ROM reserved for vectors.

To:

- Addresses \$1FF8–\$1FFF contain 8 bytes of ROM for user vectors.

4. Page 5-2, section **5.1.3 Computer Operating Properly (COP) Watchdog Reset** — Change the last sentence in the first paragraph as follows:

From:

A timeout of the COP watchdog generates a COP reset. The COP watchdog is part of a software error detection system and must be cleared periodically to start a new timeout period. To clear the COP watchdog and prevent a COP reset, write a logic zero to bit 0 (COPC) of the COP register at location \$1FF0. The COP register, shown in Figure 5-2, is a write-only register that returns the contents of a ROM location when read.

To:

A timeout of the COP watchdog generates a COP reset. The COP watchdog is part of a software error detection system and must be cleared periodically to start a new timeout period. To clear the COP watchdog and prevent a COP reset, write a logic zero to bit 0 (COPC) of the COP register at location \$1FF0. The COP register, shown in Figure 5-2, is a write-only register that returns the contents of ROM location \$1FF0 when read.

5. Page 5-2, section **5.1.3 Computer Operating Properly (COP) Watchdog Reset** — Add the following paragraph after the first paragraph:

6. Page 5-3, section **5.2.2 I/O Port Registers** — Change the first paragraph and the first bulleted item as follows:

From:

A reset has the following effects on I/O port registers:

- Clears data direction registers A, B, C, and D so that all I/O port pins are inputs (PD7/TCAP remains an input-only pin.)

To:

A reset has the following effects on I/O port registers (even if the system clock is absent):

- Clears data direction registers A, B, C, and D so that all I/O port pins are inputs (PD7/TCAP remains an input-only pin and TCMP remains an output-only pin.)

7. Page 7-5, **Figure 7-5. Data Direction Register B (DDRB)** — Change the abbreviation DDRC to DDRB as follows:

From:

DDRC — Data Direction Register B **\$0005**

To:

DDRB — Data Direction Register B **\$0005**

8. Page 7-7, section **7-4 Port C** — Change the paragraph as follows:

From:

Port C is an 8-bit general-purpose bidirectional I/O port that shares five of its

inputs. Software can select one of these four pins as the input channel to the ADC.

Unused analog input pins can be used as digital inputs, but no analog input pin can be used as a digital output while the ADC is on. Only pins PC0–PC2 can be used as digital outputs when the ADC is on.

The port C data register reads normally while the ADC is on, except that the bit corresponding to the currently selected ADC input pin reads as logic zero. Writing to bits PC7–PC3 or to bits DDRC7–DDRC3 while the ADC is on can produce unpredictable ADC results.

9. Page 8-2, section 8.1.1 Input Capture — Change the last sentence in the first paragraph as follows:

From:

The polarity of the active edge is a mask option.

To:

The polarity of the active edge is programmable in the timer control register.

10. Page 8-6, **Figure 8-5. Timer Status Register (TSR)** — Correct the address of the timer status register as follows:

From:

TSR — Timer Status Register **\$0012**

	Bit 7	6	5	4	3	2	1	Bit 0
	ICF	OCF	TOF	0	0	0	0	0
RESET :	U	U	U	0	0	0	0	0

U = UNAFFECTED

Figure 8-5. Timer Status Register (TSR)

To:

TSR — Timer Status Register **\$0013**

	Bit 7	6	5	4	3	2	1	Bit 0
	ICF	OCF	TOF	0	0	0	0	0
RESET :	U	U	U	0	0	0	0	0

U = UNAFFECTED

Figure 8-5. Timer Status Register (TSR)

11. Page 9-2, section **9.1.1 SIOP Pin Functions** — Replace the two paragraphs as follows:

From:

The SIOP uses the three port B I/O pins. Setting the SPE bit in the SIOP control register enables the SIOP. When the SPE bit is set, the PB7/SCK, PB6/SDI, and PB5/SDO pins are dedicated to SIOP functions. When the SPE bit is clear, the PB7/SCK, PB6/SDI, and PB5/SDO are bidirectional port B I/O pins.

Setting the MSTR bit in the SIOP control register configures the SIOP for master mode. In master mode, the PB7/SCK pin is the serial clock output. PB6/SDI is the serial data input pin, and PB5/SDO is the serial data output pin. The master MCU initiates and controls the transmission of data to and from one or more slave peripheral devices. In master mode, a transmission is initiated by writing to the SIOP data register. Data written to the SIOP data register is parallel-loaded and shifted out serially to the slave device(s).

To:

PB7/SCK, PB6/SDI, and PB5/SDO form the three-bit shared-function I/O port B. The port B pins can be either the SIOP I/O pins or general-purpose I/O pins.

NOTE

Do not use port B for general-purpose I/O while the SIOP is enabled.

When bit 6 (SPE) of the SIOP control register (SCR) is set, the SIOP is enabled and port B is dedicated to SIOP functions. Clearing SPE disables the SIOP and port B reverts to standard parallel I/O.

NOTE

After SPE is set, the PB5/SDO output driver can be disabled by writing a zero to DDRB5, configuring PB5/SDO as a high-impedance input.

When MSTR is a logic zero, the SIOP is configured for slave mode. PB6/SDI and PB5/SDO have the same functions as they do in master mode, but PB7/SCK is configured as an input.

12. Page 9-5. Replace the description of the SPE bit as follows:

From:

SPE — SIOP Enable

This read/write bit enables the SIOP. Clearing the SPE bit during a transmission aborts the transmission and returns port B to its normal I/O function. After clearing the SPE bit, be sure to initialize the port B data direction register for the intended port B I/O use. Resets clear SPE.

1 = SIOP enabled

0 = SIOP disabled

To:

SPE — SIOP Enable

This read/write bit enables the SIOP. Setting SPE initializes data direction register B such as follows:

- PB6/SDI is an input.
- PB5/SDO is an output
- PB7/SCK is an input in slave mode or an output in master mode.

Clearing SPE disables the SIOP and returns port B to its normal I/O functions. Data direction register B and the port B data register remain in their SIOP-initialized state. After clearing SPE, be sure to initialize port B for its intended I/O use.

13. Page 9-6. Replace the descriptions for the SPIF bit and the DCOL bit as follows:

From:

SPIF — SIOPI Interrupt Flag

This clearable, read-only bit is set automatically at the end of a transmission. Clear the SPIF bit by reading the SIOPI status register with SPIF set, and then reading or writing the SIOPI data register. Resets clear the SPIF bit.

- 1 = Serial transmission complete
- 0 = Serial transmission not complete

DCOL — Data Collision

This clearable, read-only bit is set if the SIOPI data register is read or written during a transmission. Clear the DCOL bit by reading the SIOPI status register with the SPIF bit set, and then reading or writing the SIOPI data register. Resets clear the DCOL bit.

- 1 = Invalid access of SIOPI data register
- 0 = No invalid access of SIOPI data register

To:

SPIF — SIOPI Interrupt Flag

This clearable, read-only bit is set automatically on the eighth rising edge of SCK and indicates that a data transfer took place. SPIF does not inhibit further transmissions. Clear SPIF by reading the SIOPI status register while SPIF is set and then reading or writing the SIOPI data register. Reset clears SPIF.

DCOL — Data Collision Flag

This clearable, read-only bit is automatically set if the SIOPI data register is accessed while a data transfer is in progress. Reading or writing the SIOPI data register while a transfer is in progress results in invalid data being transmitted or read. Clear DCOL by reading the SIOPI status register with SPIF set and then accessing the SIOPI data register. Because the clearing sequence accesses the

14. Page 9-6. Change the reset states in **Figure 9-6. SIOP Data Register (SDR)** as follows:

From:

SDR — SIOP Data Register **\$000C**

	Bit 7	6	5	4	3	2	1	Bit 0
RESET :	0	0	0	0	0	0	0	0

Figure 9-6. SIOP Data Register (SDR)

To:

SDR — SIOP Data Register **\$000C**

	Bit 7	6	5	4	3	2	1	Bit 0
RESET :	UNAFFECTED BY RESET							

Figure 9-6. SIOP Data Register (SDR)

15. Page 10-2, section **10.1 ADC Operation** — Change the second paragraph as follows:

From:

A comparator makes successive comparisons to the selected analog input and the output of a precision digital-to-analog converter (DAC). Control logic changes the input to the DAC one bit at a time, starting with the MSB, until the DAC output matches the selected analog input. The conversion is monotonic and has no missing codes. At the end of 32 internal clock cycles, the

16. Page 10-4. Add the following material to the end of the ADRC bit description:

When the internal RC oscillator is being used as the ADC clock, two limitations apply:

- Because of the frequency tolerance of the RC oscillator and its asynchronism with the internal clock, the conversion complete flag must be used to determine when a conversion sequence is complete.
- The RC oscillator drives the conversion process at the nominal frequency of 1.5 MHz, but the slower internal clock transfers the conversion results to the ADC data register.

17. Page 11-2, section **11.3 Self-Check Circuit** — Change the self-check activation procedure as follows:

From:

1. Apply V_{TST} to the \overline{IRQ} pin.
2. Apply a logic zero to the \overline{RESET} pin.
3. Apply a logic one to the PD1 pin.
4. Apply a logic one to the PB2 pin.
5. Apply a logic one to the \overline{RESET} pin.

To:

1. Apply V_{TST} to the \overline{IRQ} pin.
2. Apply a logic zero to the \overline{RESET} pin.
3. Apply a logic one to the \overline{RESET} pin.

18. Page 13-7, **Table 13-5. A/D Converter Characteristics** — Change the **Max** column in the second row of Table 13-5 as follows

19. Page 13-9, **Figure 13-4. TCAP Timing** — Change the t_{TLTL} parameter to t_{LIL} as follows:

From:

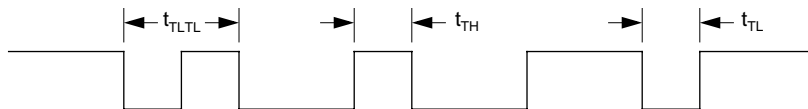


Figure 13-4. TCAP Timing

To:

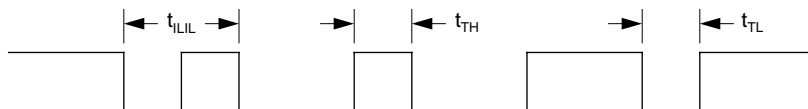


Figure 13-4. TCAP Timing

20. Page 13-12, **Table 13-8. SIOP Timing ($V_{DD} = 5.0$ Vdc)** — Change the first row as follows:

From:

Table 13-8. SIOP Timing ($V_{DD} = 5.0$ Vdc)

Characteristic	Symbol	Min	Max	Unit
Frequency of Operation Master	$f_{SIOP(M)}$	0.25	0.25	f_{OP}
Slave	$f_{SIOP(S)}$	dc	525	kHz

To:

Table 13-8. SIOP Timing ($V_{DD} = 5.0$ Vdc)

21. Page 13-13, **Table 13-9. SIOP Timing ($V_{DD} = 3.3$ Vdc)** — Change the first row as follows:

From:

Table 13-9. SIOP Timing ($V_{DD} = 3.3$ Vdc)

Characteristic	Symbol	Min	Max	Unit
Frequency of Operation Master Slave	$f_{SIOP(M)}$ $f_{SIOP(S)}$	0.25 dc	0.25 250	f_{OP} kHz

To:

Table 13-9. SIOP Timing ($V_{DD} = 3.3$ Vdc)

Characteristic	Symbol	Min	Max	Unit
Frequency of Operation Master Slave	$f_{SIOP(M)}$ $f_{SIOP(S)}$	$f_{OSC}/64$ dc	$f_{OSC}/8$ 250	MHz kHz

Change NOTE 2 at the bottom of the table as follows:

From:

- 2. $f_{OP} = 1.0$ MHz maximum

To:

- 2. f_{OSC} = crystal frequency; $f_{OP} = f_{OSC} \div 2$; $t_{CYC} = 1 \div f_{OP}$ (See Table 13-7. Control Timing ($V_{DD} = 3.3$ Vdc).)

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